TOSHIBA Photocoupler Photorelay

TLP3105

Measurement Equipment FA (Factory Automation) Power Line Control Security Equipment

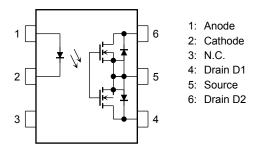
The Toshiba TLP3105 consists of an infrared emitting diode optically coupled to a photo-MOSFET in a SOP, which is suitable for surfacemount assembly. The TLP3105 features high ON-state current and low ON-state resistance, hence the TLP3105 is suitable to control a power line.

- 6-pin SOP (2.54SOP6): 2.1 mm high, 2.54 mm pitch
- Normally opened (form A) device
- Peak OFF-state voltage: 100 V (min)
- Trigger LED current: 3 mA (max)
- ON-state current: 1.4 A (max) (Ta=50°C)
- ON-state resistance: 0.1Ω (typ.), 0.2Ω (max)
- Capacitance between output terminals: 1000 pF (typ.)
- OFF-state current: 10 nA (max)
- Isolation voltage: 1500 V_{rms} (min)
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A File No.E67349

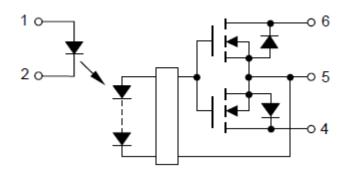
Unit: mm 6 5 4 7 7 0 ± 0.4 1 2 3 7 0 ± 0.4 2.54 ± 0.25 0.4 ± 0.1 JEDEC — JEITA — TOSHIBA 11-7C1

Weight: 0.13 g (typ.)

Pin Configuration (top view)



Schematic



Start of commercial production 2010-06

TLP3105



Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit		
	Forward current		lF	30	mA	
	Forward cur	rent derating (Ta ≥ 25°C)	ΔI _F /°C	-0.3	mA/°C	
	Reverse vol	tage	VR	5	V	
LED	Diode power	r dissipation	P _D	50	mW	
	Diode power dissipation derating (Ta ≥25°C)		ΔP _D /°C	-0.5	mW/°C	
	Junction tem	nperature	Tj	125	°C	
	Off-state output terminal voltage		Voff	100	V	
	On-state current	A connection		1.4		
		B connection	Ion	1.4	Α	
		C connection		2.8		
	On-state current derating (Ta ≥ 50°C)	A connection		-18.7		
.		B connection	ΔI _{ON} /°C	-18.7	mA/°C	
Detector		C connection		-37.3		
	Pulse on-state current (t = 100ms)		IONP	4	Α	
	Output power dissipation		Po	196	mW	
	Output power dissipation derating (Ta ≥ 50°C)		ΔP _O /°C	-2.62	mW / °C	
	Junction tem	nperature	Tj	125	°C	
Storage to	Storage temperature		T _{stg}	-55 to 125	°C	
Operating	Operating temperature			-40 to 85	°C	
Lead solo	Lead soldering temperature (10 s)			260	°C	
Isolation	voltage (AC, 6	60 s, R.H. ≤ 60 %) (Note 1)	BVS	1500	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

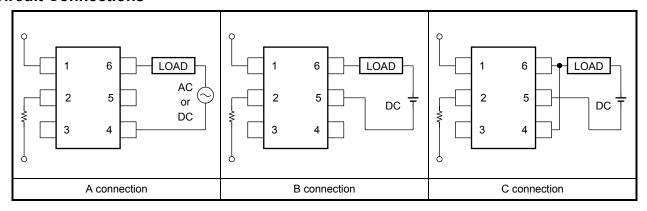
Note 1: Device considered a two-terminal device: Pins 1 and 2 shorted together, and pins 4, 5 and 6 shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	V_{DD}	_	_	100	V
Forward current	lF	_	7.5	20	mA
Operating temperature	T _{opr}	-20		65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Circuit Connections



Individual Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	I _F = 10 mA	1.18	1.33	1.48	V
LED	Reverse current	I _R	V _R = 5 V	_	1	10	μΑ
	Capacitance	CT	V _F = 0 V, f = 1 MHz	_	70	_	pF
tor	OFF-state current	loff	V _{OFF} = 100 V	-	l	10	nA
Detector	Capacitance	Coff	V = 0 V, f = 1 MHz	_	1000	_	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current		lfT	I _{ON} = 100 mA	_	_	3	mA
Return LED current		IFC	I _{OFF} = 10 μA	0.1	_	_	mA
	A connection	-	I _{ON} = 1.4 A, I _F = 5 mA, t<1 s	_	0.1	0.2	
On-state resistance	B connection		I _{ON} = 1.4 A, I _F = 5 mA, t<1 s	_	0.05	0.1	Ω
	C connection		I _{ON} = 2.8 A, I _F = 5 mA, t<1 s	_	0.025	_	

Isolation Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	Cs	V _S = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation resistance	Rs	V _S = 500 V, R.H. ≤ 60 %	5×10^{10}	10 ¹⁴	_	Ω
Isolation voltage	BVs	AC, 60 s	1500		_	Vrms

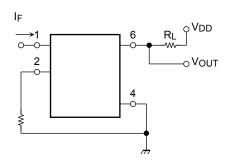
© 2019 3 Toshiba Electronic Devices & Storage Corporation

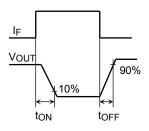


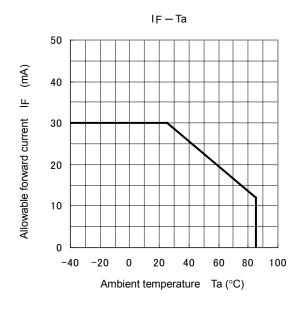
Switching Characteristics (Ta = 25°C)

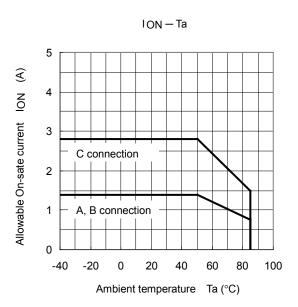
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-ON time	ton	$R_L = 200 \Omega$	_	1.0	5.0	
Turn-OFF time	toff	$V_{DD} = 20 \text{ V, I}_F = 5 \text{ mA}$ (Note	= 2)	0.15	1.0	ma
Turn-ON time	ton	R _L = 200 Ω	_	0.5	3.0	ms
Turn-OFF time	toff	$V_{DD} = 20 \text{ V, I}_{F} = 10 \text{ mA}$ (Not	= 2)	0.15	1.0	

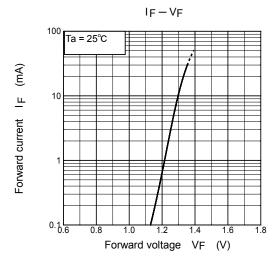
Note 2: Switching time test circuit

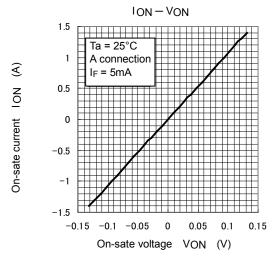


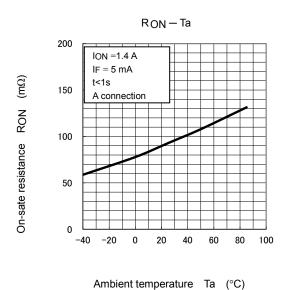


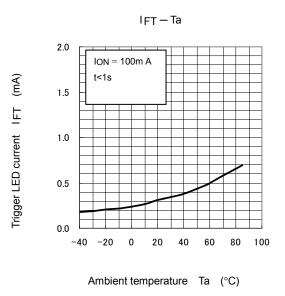










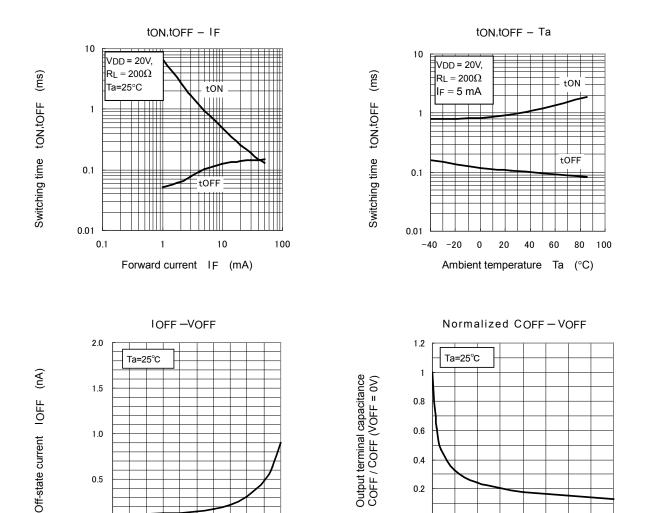


NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

0.0

20

Off-state output voltage VOFF



NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

100

(V)

0

0

10

20

Off-state output voltage VOFF

30

40

(V)

RESTRICTIONS ON PRODUCT USE

Toshiba Corporation and its subsidiaries and affiliates are collectively referred to as "TOSHIBA". Hardware, software and systems described in this document are collectively referred to as "Product".

- TOSHIBA reserves the right to make changes to the information in this document and related Product without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications. TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.
- PRODUCT IS NEITHER INTENDED NOR WARRANTED FOR USE IN EQUIPMENTS OR SYSTEMS THAT REQUIRE
 EXTRAORDINARILY HIGH LEVELS OF QUALITY AND/OR RELIABILITY, AND/OR A MALFUNCTION OR FAILURE OF WHICH
 MAY CAUSE LOSS OF HUMAN LIFE, BODILY INJURY, SERIOUS PROPERTY DAMAGE AND/OR SERIOUS PUBLIC IMPACT
 ("UNINTENDED USE"). Except for specific applications as expressly stated in this document, Unintended Use includes, without
 limitation, equipment used in nuclear facilities, equipment used in the aerospace industry, lifesaving and/or life supporting medical
 equipment, equipment used for automobiles, trains, ships and other transportation, traffic signaling equipment, equipment used to
 control combustions or explosions, safety devices, elevators and escalators, and devices related to power plant. IF YOU USE
 PRODUCT FOR UNINTENDED USE, TOSHIBA ASSUMES NO LIABILITY FOR PRODUCT. For details, please contact your
 TOSHIBA sales representative or contact us via our website.
- Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE
 FOR PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY
 WHATSOEVER, INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR
 LOSS, INCLUDING WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND
 LOSS OF DATA, AND (2) DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO
 SALE, USE OF PRODUCT, OR INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS
 FOR A PARTICULAR PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.
- GaAs (Gallium Arsenide) is used in Product. GaAs is harmful to humans if consumed or absorbed, whether in the form of dust or vapor. Handle with care and do not break, cut, crush, grind, dissolve chemically or otherwise expose GaAs in Product.
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). Product and related software and technology may be controlled under the applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of
 Product. Please use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled
 substances, including without limitation, the EU RoHS Directive. TOSHIBA ASSUMES NO LIABILITY FOR DAMAGES OR LOSSES
 OCCURRING AS A RESULT OF NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.

TOSHIBA ELECTRONIC DEVICES & STORAGE CORPORATION

https://toshiba.semicon-storage.com/

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET Output Optocouplers category:

Click to view products by Toshiba manufacturer:

Other Similar products are found below:

TLP598GAF TLP4026G(F) TLP4176A(F TLP3147(F TLP3146(F H11AV1XSM LTV-817-L LTV-817M-D LTV-817S-TA1-L TIL111

TIL191 MCT6XSM TLP170G(F) TLP227GA-2(TP1,F) TLP797J(F) 4N35X 4N35XSM ILD1XSM ILQ2X IS357A ISP521-1X ISP521
1XSM ISP521-4XSM ISP620-1XSM ISP621-4X ISP621-4XSM SFH617A-3XSM SFH620A-3X CNY17-2-L CNY17-4-L TIL111XSM

TIL193 TIL199 CNY17-4X CNY17-1X IS355 TLP209D(F) TLP3544(F) TLP592A(F) TLP521-1X TLP3546(F) TLP3543(F) CNY17F
3X ISP847XSM ISP844XSM ISP827X CNY17F-1XSM CNY17-3X CNY17-1XSM IS181A